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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Cheng-Lien Chiang
Assignee: Bridge Semiconductor Corporation
Title: SEMICONDUCTOR PACKAGE DEVICE
Serial No.: 10/042,812 Filed: January 9, 2002
Examiner: Unknown Group Art Unit: Unknown
Atty. Docket No.: BDG005

ASSISTANT COMMISSIONER FOR PATENTS
Washington, D.C. 20231

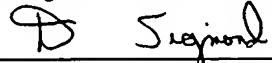
INFORMATION DISCLOSURE STATEMENT

Pursuant to Applicant's duty of disclosure under 37 C.F.R. § 1.56 and §§ 1.97-1.98,
Applicant hereby provides a copy of the documents identified on the enclosed Form PTO-1449.

The filing of this Information Disclosure Statement shall not be construed as a representation that a search has been made, an admission that any of these documents, alone or in any combination, is considered to be material to patentability, an admission that any of these documents is prior art as to the above-identified application, or an admission against interest in any manner.

This Information Disclosure Statement is filed before the mailing date of a first Office Action on the merits. Accordingly, no fee is due. 37 C.F.R. § 1.97(b)(3).

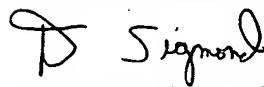
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1/29/02
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Respectfully submitted,



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